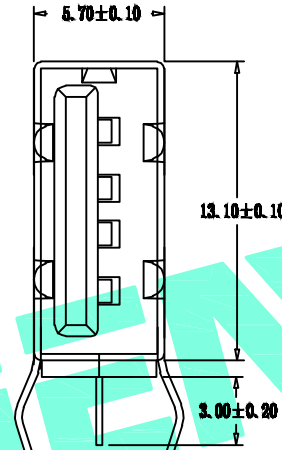
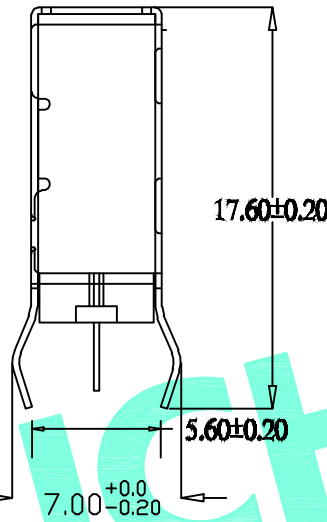
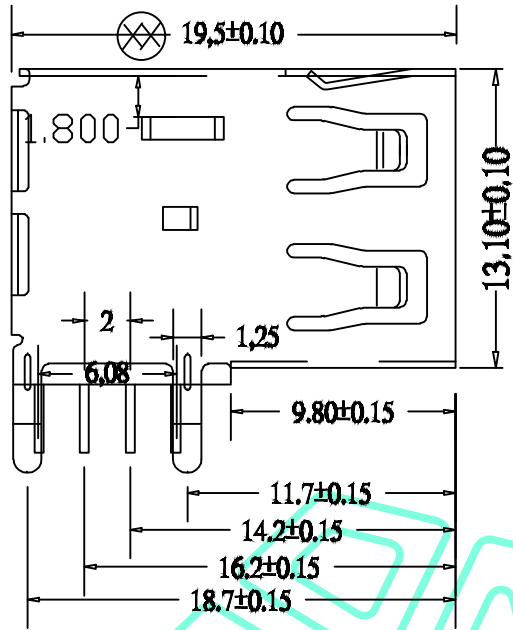


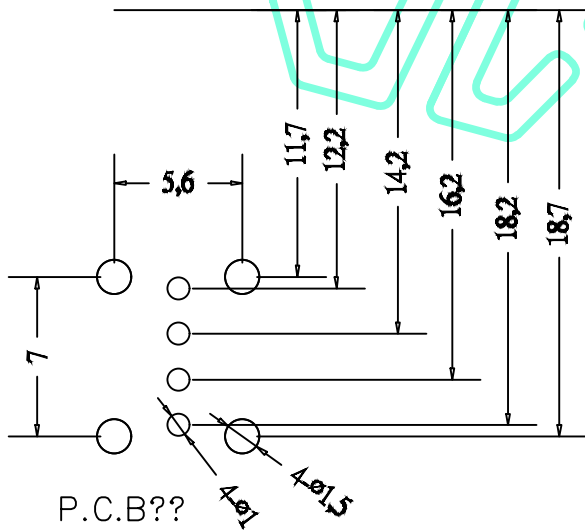
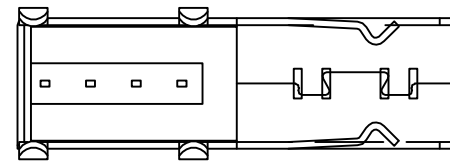
RoHS Compliant

REV.	DESCRIPTION	DESIGN	DATE
A/0	NEW	CWF	



NOTES:

- MATERIAL SPECIFICATION
 - INSULATION MATERIAL: THERMOPLASTIC.
 - SHELL: COPPER ALLOY/SPCC, T: 0.30mm
PLATING: NICKEL.
 - TERMINAL: COPPER ALLOY, T: 0.25mm
PLATING: GOLD/TIN PLATED.
 - ELECTRICAL CHARACTERISTIC:
 - INSULATION RESISTANCE: 1000MΩ MIN.
 - CONTACT RESISTANCE: 30mΩ MAX.
 - WITHSTANDING VOLTAGE: 500V AC.
 - MECHANICAL CHARACTERISTICS:
 - INSERTION FORCE: 3.57Kgf MAX.
 - EXTRACTION FORCE: 1.02Kgf MIN.
- ORDERING INFORMATION



THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF SHENZHEN YUCHENG ELECTRONICS, LTD. AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF SHENZHEN YUCHENG ELECTRONICS, LTD.



深圳市裕诚电子有限公司
SHENZHEN YUCHENG ELECTRONICS CO., LTD

APPROVED:	WEI JIE	GENERAL TOLERANCES	TITLE:	USB 2.0AF 侧插长体直边
CHECKED:	HONG JIN YUN	30~以上 ±0.30	PART NO.:	USB-C195Z
DRAWING:	CHEN YA	10~30 ±0.25	WEBSITE:	www.ycelectron.com
		5~10 ±0.20	REV: A	UNIT: mm
		~ 5 ±0.15		SCALE: /
		SHEET: 1 / 1		SHEET: A4

